

23rd International Systems and Software Product Line Conference

Sept 9-13, 2019 • Paris, France

SPLC 2019

Call for Papers, Workshops, Tutorials, and Panels

The Systems and Software Product Line Conference (SPLC) is a premier forum where researchers, practitioners, and educators can present and discuss the most recent ideas, trends, experiences, and challenges in the area of software and system product lines engineering. Conference events include opportunities to hear industry leaders' real-world experiences and researchers' latest ideas and to learn from both.

The 23rd International Systems and Software Product Line Conference (SPLC 2019) will be held from September 9th to 13th, in the vibrant city of Paris, France.

Research Papers: We invite high quality submissions describing original and unpublished results in all areas related to systems and software product line engineering and variability management.

Industrial Systems and Software Product Lines: We invite submission of papers presenting challenges, innovations and solutions to concrete industrial applications of software and product line engineering methodologies and tools. Submitted papers should showcase a significant software component to the research.

Challenges, and Solutions Papers: We highly encourage community members to provide concrete sets of case studies and problems that showcase SPL-related challenges. First, there will be a call for cases where researchers or practitioners are encouraged to contribute a concrete case study. Then, after the accepted case studies are published, there will be a call for solutions. Both accepted case descriptions and solutions will be included in the conference proceedings.

Journal First Papers: Authors of journal-first papers are invited to submit their publications to present their work at SPLC. This is an opportunity to speak directly to the community and offer SPLC attendees a richer set of presentations.

Workshops Proposals: We invite the community to submit proposals for one or two-day workshops in the field. In particular, workshops on challenging, emerging areas related to conference topics.

Demonstrations and Tools: This track highlights live demonstrations of product-line tools and of practices tackling current industrial challenges.

Doctoral Symposium: This track highlights doctoral proposals, both early and mid-phase, to be reviewed and commented on by a panel of experts.

Tutorials: Tutorials provide a valuable opportunity for participants to expand their knowledge and skills in product line engineering. Tutorials may focus on introductory product lines topics, or on advanced tools, approaches, methods, and best practices.

Panels: SPLC provides multiple opportunities for exchanging and discussing ideas and visions for software product line engineering. We call for your proposals for panels on software product line related topics.

General Chairs

Camille Salinesi, France
Tewfik Ziadi, France

Research Track

Laurence Duchien, France
Thomas Thüm, Germany

Workshops

Carlos Cetina, Spain
Christoph Seidl, Germany

Doctoral Symposium

Oscar Díaz, Spain
Marianne Huchard, France

Tutorials

Philippe Collet, France
Leticia Montalvillo, Spain

Panels

TBA

Industry Track

Patrick Heymans, Belgium
Thomas Fogdal, Denmark

Hall of Fame

Natsuko Noda, Japan
Goetz Botterweck, Ireland

Challenges

Jabier Martinez, Spain
Timo Kehrer, Germany

Journal First

Raul Mazo, France

Demonstrations and Tools

Leopoldo Teixeira, Brazil
Rick Rabiser, Austria

Local Organisation

Lom M. Hillah, France
Jacques Robin, France

Web

Anas Shatnawi, France

Proceedings

Xhevahire Ternava, France

Finance

Thùy Dodo, France

Publicity and Social Media

Clément Quinton, France
Sébastien Mosser, France
Wesley K.G. Assunção, Brazil

Student Volunteers

Juliana Alves Pereira, France

IMPORTANT DATES

Research/Industrial paper submission	March, 2019
Challenge cases	January, 2019
Journal first paper submission	May, 2019
Workshops proposals	February, 2019
Tutorials	May, 2019
Demonstrations and Tools	May, 2019
Doctoral Symposium	April, 2019